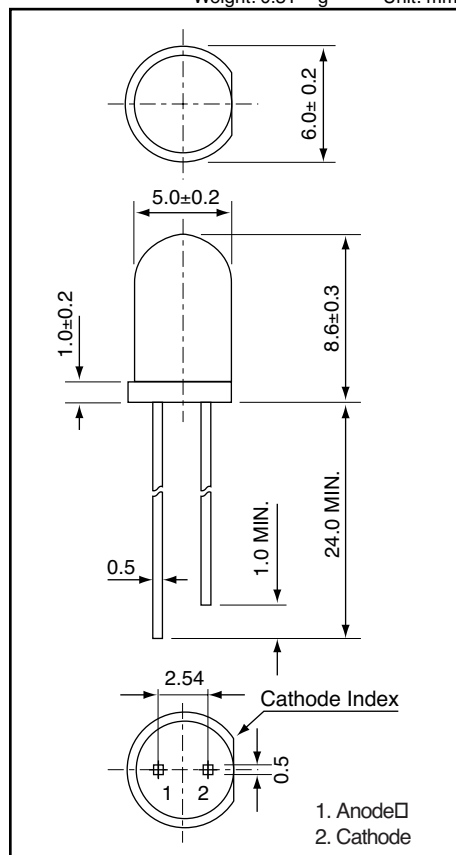




Weight: 0.31 g Unit: mm



AND157HSP

InGaAlP High Brightness Soft Red Light Emission

5mm (T1-3/4) Package

Features

- Peak wavelength ($\lambda_p=632$ nm) high bright emission
- All plastic mold type, clear colorless lens
- Low drive current: 1 ~ 20 mA DC
- Excellent On-Off contrast ratio
- Fast response time, capable of pulse operation
- High power intensity – suitable for outdoor usage
- High reliability, storage temp. $-40 \sim 85^\circ\text{C}$

Maximum Ratings ($T_a = 25^\circ\text{C}$)

Characteristics	Symbol	Rating	Unit
Forward Current	I_F	50	mA
Reverse Voltage	V_R	5	V
Power Dissipation	P_D	125	mW
Operating Temperature Range	T_{Opr}	-40 to 85	$^\circ\text{C}$
Storage Temperature Range	T_{Stg}	-40 to 100	$^\circ\text{C}$
Peak Forward Current Duty 1/10, Pulse Width 10 ms	IFP	160	mA

Electro-Optical Characteristics ($T_a = 25^\circ\text{C}$)

Characteristics	Symbol	Test Condition	Minimum	Typical	Maximum	Unit
Forward Voltage	V_F	$I_F = 20$ mA	–	2.0	2.6	V
Reverse Current	I_R	$V_R = 5$ V	–	–	50	μA
Luminous Intensity	I_V	$I_F = 20$ mA	4,500	5,650	–	mcd
Peak Emission Wavelength	λ_P	$I_F = 20$ mA	–	632	–	nm
Spectral Line Half Width	λ_{Δ}	$I_F = 20$ mA	–	20	–	nm
Dominant Wavelength	λ_d	$I_F = 20$ mA	–	615	–	nm
Full Viewing Angle	$2\theta_{1/2}$	$I_V = 1/2$ Peak	–	30	–	degree

Precaution

Please be careful of the following:

1. Soldering temperature: 260°C max., Soldering time: 5 sec. max.
Soldering portion of lead: up to 1.6 mm from the body of the device
2. Reflow solder: recommended condition is as follows:

Product specifications contained herein may be changed without prior notice.
It is therefore advisable to contact Purdy Electronics before proceeding with the design of equipment incorporating this product.

